

THIS DEVICE IS **DISCONTINUED**

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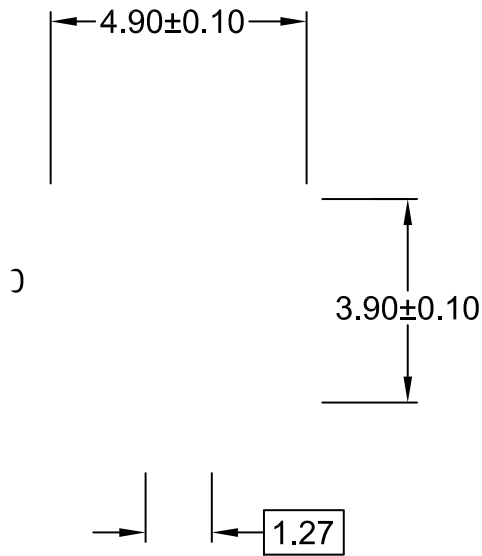




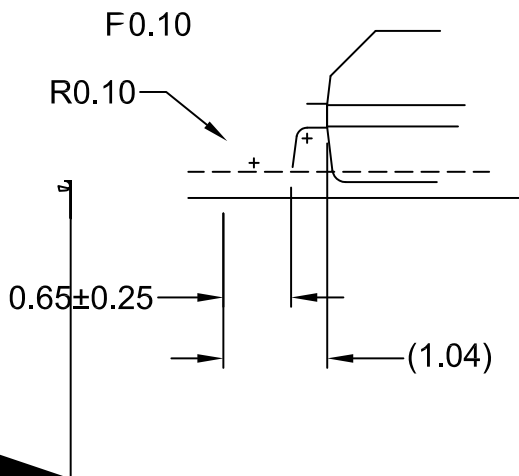
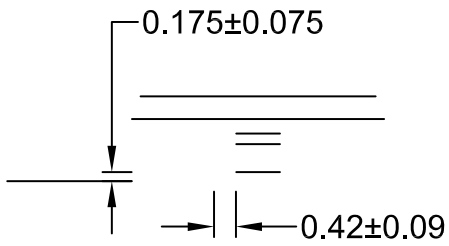


SOIC8  
CASE 751EB  
ISSUE A

DATE 24 AUG 2017



LAND PATTERN RECOMMEND/



12, VARIATION AA.  
B) ALL DIMENSI

OLD

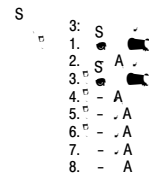
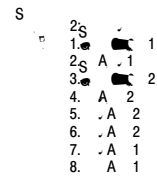
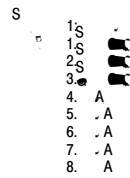
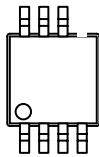
FLASH OR BURRS.  
D) LANDPATTERN STANDARD: SOIC127P600X175-8M



SCALE 2:1

Micro8  
CASE 846A-02  
ISSUE K

DATE 16 JUL 2020



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